

PC3SD21NTZ Series

*Non-zero cross type is also available. (**PC3SD11NTZ Series**)

V_{DRM}: 600V Zero cross type DIP 6pin Phototriac Coupler for triggering



■ Description

PC3SD21NTZ Series Phototriac Coupler include an infrared emitting diode (IRED) optically coupled to an output Phototriac.

These devices feature full wave control and are ideal isolated drivers for medium to high current Triacs.

DIP package provides 5.0kV isolation from input to output with superior commutative noise immunity.

■ Features

- 1. High repetitive peak off-state voltage (V_{DRM}: 600V)
- 2. Zero crossing functionality (Vox: MAX. 20V)
- 3. I_{FT} ranks available (see Model Line-up section in this datasheet)
- 4. 6 pin DIP package
- 5. Superior noise immunity (dV/dt : MIN. 1 000V/µs)
- 6. Double transfer mold construction (Ideal for Flow Soldering)
- 7. High isolation voltage between input and output (Viso(rms): 5.0kV)

■ Agency approvals/Compliance

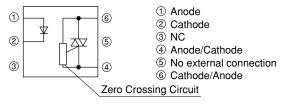
- Recognized by UL1577 (Double protection isolation), file No. E64380 (as model No. 3SD21)
- 2. Approved by CSA, file No. CA95323 (as model No. **3SD21**)
- 3. Optionary available VDE Approved (*)(DIN EN 60747-5-2), file No. 4008189 (as model No. **3SD21**)
- 4. Package resin: UL flammability grade (94V-0)
 - (*) DIN EN60747-5-2: succesor standard of DIN VDE0884. Up to Date code "RD" (December 2003), approval of DIN VDF0884.
 - From Date code "S1" (January 2004), approval of DIN EN60747-5-2.
 - (**) Reinforced insulation type is also available. (PC3SF21YVZ Series)

■ Applications

- 1. Triggering for Triacs used to switch on and off devices which require AC Loads.
 - For example heaters, fans, motors, solenoids, and valves.
- 2. AC line control in power supply applications.

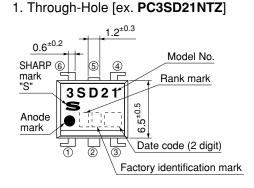


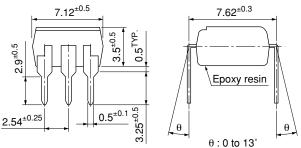
■ Internal Connection Diagram



■ Outline Dimensions

(Unit : mm)



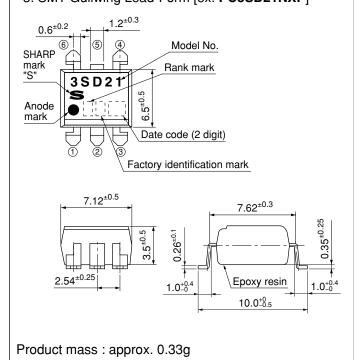


Product mass : approx. 0.35g

2. Wide Through-Hole Lead-Form [ex. PC3SD21NVZ] 0.6^{±0.2} Model No. SHARP mark "S" Rank mark 3 S D 2 1 Anode mark Date code (2 digit) (3) Factory identification mark 2 7.12^{±0.5} 7.62^{±0.3} 0.5^{TYP}. Epoxy resin 0.26^{±0.1} $10.16^{\pm0.5}$ 2.54^{±0.25} 0.5^{±0.1} [†]5

Product mass: approx. 0.35g

3. SMT Gullwing Lead-Form [ex. PC3SD21NXP]



 $0.6^{\pm0.2}$ (5) Model No. SHARP mark "S" Rank mark 3 S D 2 1 Anode mark + 1 Date code (2 digit) ① ① ³Factory identification mark .5±0.5 7.62^{±0.3} 7.12^{±0.5} .26^{±0}. Epoxy resin 2.54^{±0.25} 10.16^{±0.5} 0.75^{±0.25} $0.75^{\pm0.25}$ 12.0^{MAX.} Product mass: approx. 0.34g

4. Wide SMT Gullwing Lead-Form [ex. PC3SD21NWP]

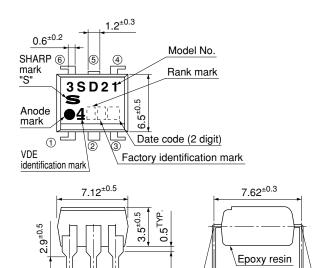


■ Outline Dimensions (Unit : mm)

θ

 $\theta : 0 \text{ to } 13^{\circ}$

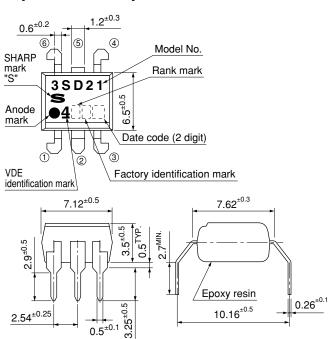
5. Through-Hole VDE option [ex. **PC3SD21YTZ**]



Product mass: approx. 0.35g

 $2.54^{\pm0.25}$

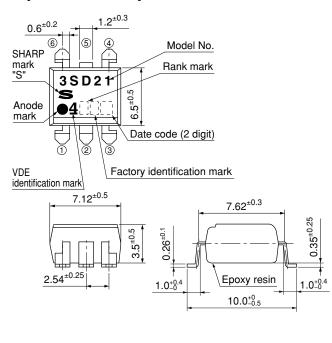
6. Wide Through-Hole Lead-Form VDE option [ex. **PC3SD21YVZ**]



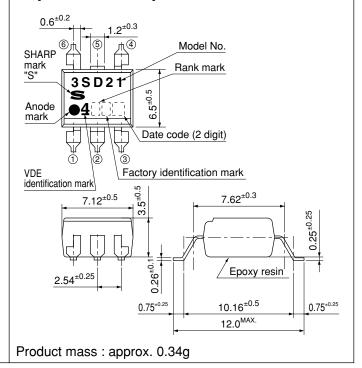
Product mass: approx. 0.35g

7. SMT Gullwing Lead-Form VDE option [ex. **PC3SD21YXP**]

3.25_{±0.1} 0.5_{±0.5}



8. Wide SMT Gullwing Lead-Form VDE option [ex. **PC3SD21YWP**]



*Pin 5 is not allowed external connection

Product mass: approx. 0.33g



Date code (2 digit)

| | 1st o | digit | | 2nd digit | | |
|------|-----------|-----------|------|---------------------|------|--|
| | Year of p | roduction | | Month of production | | |
| A.D. | Mark | A.D | Mark | Month | Mark | |
| 1990 | A | 2002 | P | January | 1 | |
| 1991 | В | 2003 | R | February | 2 | |
| 1992 | С | 2004 | S | March | 3 | |
| 1993 | D | 2005 | T | April | 4 | |
| 1994 | Е | 2006 | U | May | 5 | |
| 1995 | F | 2007 | V | June | 6 | |
| 1996 | Н | 2008 | W | July | 7 | |
| 1997 | J | 2009 | X | August | 8 | |
| 1998 | K | 2010 | A | September | 9 | |
| 1999 | L | 2011 | В | October | 0 | |
| 2000 | M | 2012 | С | November | N | |
| 2001 | N | : | : | December | D | |

repeats in a 20 year cycle

Factory identification mark

| Factory identification Mark | Country of origin |
|-----------------------------|-------------------|
| no mark | Ionon |
| | Japan |
| | Indonesia |
| $\overline{\hspace{1cm}}$ | Philippines |
| _ | China |

^{*} This factory marking is for identification purpose only.

Please contact the local SHARP sales representative to see the actural status of the production.

Rank mark

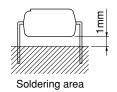
Refer to the Model Line-up table



■ Absolute Maximum Ratings

 $(T_a=25^{\circ}C)$

| | | _ | (1a 25 C) | |
|-------------|-----------------------------------|----------------|-------------|------|
| | Parameter | Symbol | Rating | Unit |
| T4 | Forward current | I_F | 50 | mA |
| Input | Reverse voltage | V_R | 6 | V |
| | RMS ON-state current | $I_{T}(rms)$ | 0.1 | A |
| Output | Peak one cycle surge current | I_{surge} | 1.2 *3 | A |
| | Repetitive peak OFF-state voltage | V_{DRM} | 600 | V |
| *1 Isolatio | on voltage | $V_{iso}(rms)$ | 5.0 | kV |
| | ing temperature | T_{opr} | -30 to +100 | °C |
| Storage | e temperature | T_{stg} | -55 to +125 | °C |
| *2Solderi | ng temperature | T_{sol} | 270*4 | °C |



■ Electro-optical Characteristics

 $(T_a=25^{\circ}C)$

| | Parameter | | Symbol | Conditions | MIN. | TYP. | MAX. | Unit |
|----------------------|--|----------------------|-----------------|---------------------------------------|--------------------|-------|------|------|
| т., | Forward voltage | | V_{F} | $I_F=20mA$ | _ | 1.2 | 1.4 | V |
| Input | Reverse current | | I_R | $V_R=3V$ | _ | _ | 10 | μΑ |
| | Repentitive peak OFF-state | current | I_{DRM} | $V_D = V_{DRM}$ | _ | _ | 1 | μΑ |
| | ON-state voltage | | V_{T} | $I_{T}=0.1A$ | _ | - | 2.5 | V |
| | Holding current | | I_{H} | $V_D=4V$ | 0.1 | _ | 3.5 | mA |
| Output | Critical rate of rise of OFF-state voltage | | dV/dt | $V_D=1/\sqrt{2} \cdot V_{DRM}$ | 1 000 | 2 000 | _ | V/µs |
| | Zero cross voltage | Rank B | V _{OX} | I _F =15mA, Resistance load | - | - | 20 | |
| | | Rank C | | I _F =8mA, Resistance load | | | | V |
| | | Rank D | | | | | | |
| | | Rank B | | | _ | _ | 7 | |
| Transfer | Minimum trigger current | Rank C | I_{FT} | $V_D=4V, R_L=100\Omega$ | _ | _ | 5 | mA |
| charac- teristics | | Rank D | | | _ | _ | 3 | |
| | Isolation resistance | Isolation resistance | | DC500V,40 to 60%RH | 5×10 ¹⁰ | 1011 | _ | Ω |
| | Turn-on time | | t _{on} | $V_D=4V, R_L=100\Omega, I_F=20mA$ | _ | _ | 50 | μs |

^{*1 40} to 60%RH, AC for 1minute, f=60Hz *2 For 10s *3 f=50Hz sine wave

^{*4} Lead solder plating models: $260^{\circ}C$



■ Model Line-up

| Lead Form | Through-Hole SMT Gullwing Wide Through-Hole | | | | | | | |
|------------------|---|--------------|--------------|--------------|--------------|--------------|---|--------------------------|
| Shipping Packag | | Sleeve | | | | | | |
| Silipping Packag | ge | 50pcs/sleeve | | | | | | I_{FT} [mA] $(V_D=4V,$ |
| DIN | | Approved | | Approved | | Approved | | $R_L=100\Omega$) |
| EN60747-5-2 | | Approved | | Approved | | Approved | | |
| | PC3SD21NTZBF | PC3SD21YTZBF | PC3SD21NXZBF | PC3SD21YXZBF | PC3SD21NVZBF | PC3SD21YVZBF | В | MAX. 7 |
| Model No. | PC3SD21NTZCF | PC3SD21YTZCF | PC3SD21NXZCF | PC3SD21YXZCF | PC3SD21NVZCF | PC3SD21YVZCF | С | MAX. 5 |
| | PC3SD21NTZDF | PC3SD21YTZDF | PC3SD21NXZDF | PC3SD21YXZDF | PC3SD21NVZDF | PC3SD21YVZDF | D | MAX. 3 |

| Lead Form | Wide SMT | Gullwing | SMT Gu | llwing | Wide SMT | Gullwing | | |
|-----------------|----------------|--------------|---------------|--------------|--------------|--------------|-----------|----------------------|
| Chinning Dooks | Sleeve | | Taping | | | | Rank mark | I _{FT} [mA] |
| Shipping Packag | e 50pcs/sleeve | | 1 000pcs/reel | | | | | $(V_D=4V,$ |
| DIN | | Approved | | Approved | | Approved | | $R_L=100\Omega$) |
| EN60747-5-2 | Approve | | | Approved | | Approved | | |
| | PC3SD21NWZBF | PC3SD21YWZBF | PC3SD21NXPBF | PC3SD21YXPBF | PC3SD21NWPBF | PC3SD21YWPBF | В | MAX. 7 |
| Model No. | PC3SD21NWZCF | PC3SD21YWZCF | PC3SD21NXPCF | PC3SD21YXPCF | PC3SD21NWPCF | PC3SD21YWPCF | С | MAX.5 |
| | PC3SD21NWZDF | PC3SD21YWZDF | PC3SD21NXPDF | PC3SD21YXPDF | PC3SD21NWPDF | PC3SD21YWPDF | D | MAX. 3 |

Please contact a local SHARP sales representative to inquire about production status.

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Fig.1 Forward Current vs. Ambient Temperature

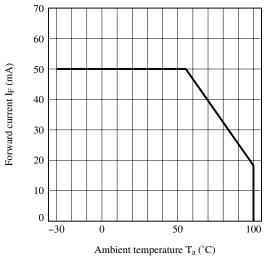


Fig.3-a Forward Current vs. Forward Voltage (Rank B)

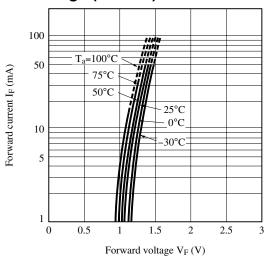


Fig.4-a Minimum Trigger Current vs.
Ambient Temperature (Rank B)

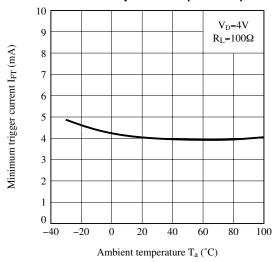


Fig.2 RMS ON-state Current vs. Ambient Temperature

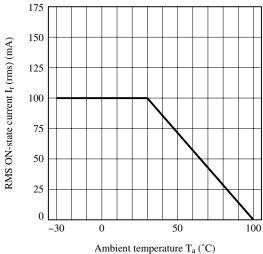


Fig.3-b Forward Current vs. Forward Voltage (Rank C, Rank D)

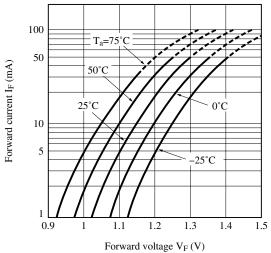


Fig.4-b Minimum Trigger Current vs. Ambient Temperature (Rank C, Rank D)

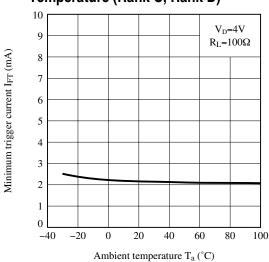




Fig.5 Relative Repetitive Peak OFF-state Voltage vs. Ambient Temperature

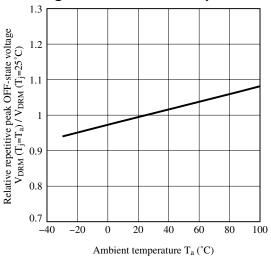


Fig.7 Holding Current vs.

Ambient Temperature

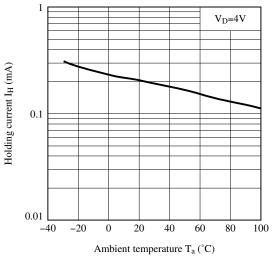


Fig.9-a Turn-on Time vs. Forward Current (Rank B)

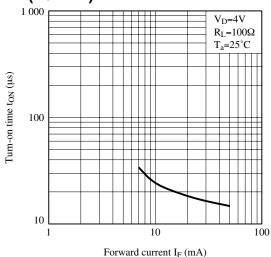


Fig.6 ON-state Voltage vs.
Ambient Temperature

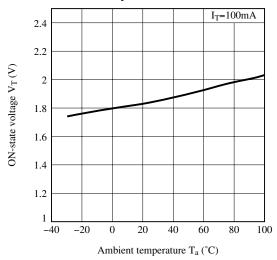


Fig.8 Repetitive Peak OFF-state Current vs. Ambient Temperature

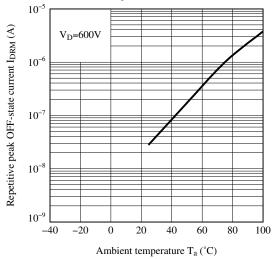
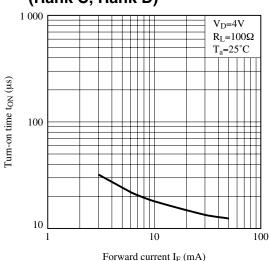


Fig.9-b Turn-on Time vs. Forward Current (Rank C, Rank D)



Sheet No.: D2-A07601FEN



Fig.10-a Zero-cross Voltage vs. Ambient Temperature (Rank B)

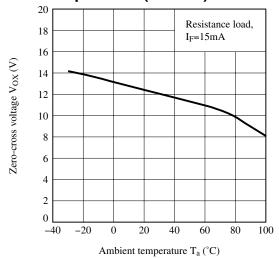
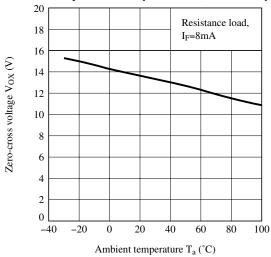


Fig.10-b Zero-cross Voltage vs. Ambient Temperature (Rank C, Rank D)



Remarks: Please be aware that all data in the graph are just for reference.



■ Design Considerations

Design guide

In order for the Phototriac to turn off, the triggering current (I_F) must be 0.1mA or less.

Please refrain from using these devices in a direct drive configuration. These Phototriac Coupler are intended to be used as triggering device for main Triacs. Please ensure that the output rating of these devices will be sufficient for triggering the main output Triac of your choice. Failure to do may result in malfunctions.

For applications with inductive loads such as motors, please use caution in utilizing a zero crossing type Phototraiac Coupler as this may cause undesired operations due to the phase difference between voltage and current of load.

For designs that will experience excessive noise or sudden changes in load voltage, please include an appropriate snubber circuit as shown in the below circuit. Please keep in mind the Sharp Phototriac Coupler incorporate superrior dV/dt ratings which can eliminate the need for a snubber circuit.

For over voltage protection, a Varistor may be used.

Degradation

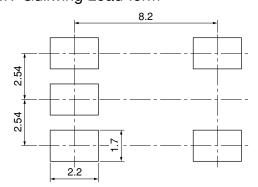
In general, the emission of the IRED used in Phototriac Couplers will degrade over time.

In the case where long term operation and / or constant extreme temperature fluctuations will be applied to the devices, please allow for a worst case scenario of 50% degradation over 5years.

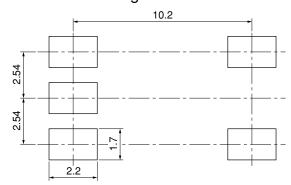
Therefore in order to maintain proper operation, a design implementing these Phototriac Couplers should provide at least twice the minimum required triggering current from initial operation.

Recommended Foot Print (reference)

SMT Gullwing Lead-form



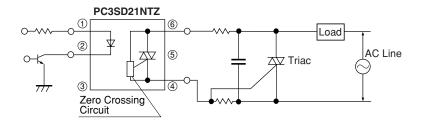
Wide SMT Gullwing Lead-form



(Unit: mm)



Standard Circuit (Medium/High Power Triac Drive Circuit)



Note) Please add the snubber circuit according to a condition.

Any snubber or varistor used for the above mentioned scenarios should be located as close to the main output triac as possible.

[☆] For additional design assistance, please review our corresponding Optoelectronic Application Notes.



■ Manufacturing Guidelines

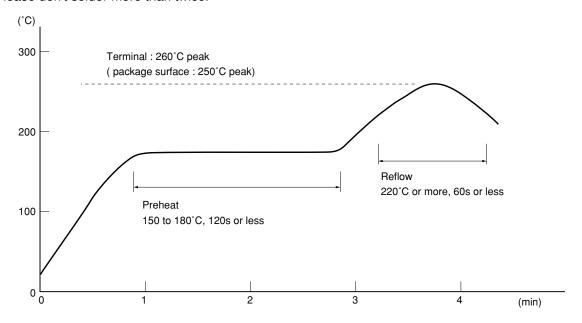
Soldering Method

Reflow Soldering:

Reflow soldering should follow the temperature profile shown below.

Soldering should not exceed the curve of temperature profile and time.

Please don't solder more than twice.



Flow Soldering:

Due to SHARP's double transfer mold construction submersion in flow solder bath is allowed under the below listed guidelines.

Flow soldering should be completed below 270°C and within 10s.

Preheating is within the bounds of 100 to 150°C and 30 to 80s.

Please don't solder more than twice.

Hand soldering

Hand soldering should be completed within 3s when the point of solder iron is below 400°C.

Please don't solder more than twice.

Other notices

Please test the soldering method in actual condition and make sure the soldering works fine, since the impact on the junction between the device and PCB varies depending on the tooling and soldering conditions.



Cleaning instructions

Solvent cleaning:

Solvent temperature should be 45°C or below. Immersion time should be 3minutes or less.

Ultrasonic cleaning:

The impact on the device varies depending on the size of the cleaning bath, ultrasonic output, cleaning time, size of PCB and mounting method of the device.

Therefore, please make sure the device withstands the ultrasonic cleaning in actual conditions in advance of mass production.

Recommended solvent materials:

Ethyl alcohol, Methyl alcohol and Isopropyl alcohol.

In case the other type of solvent materials are intended to be used, please make sure they work fine in actual using conditions since some materials may erode the packaging resin.

Presence of ODC

This product shall not contain the following materials.

And they are not used in the production process for this device.

Regulation substances: CFCs, Halon, Carbon tetrachloride, 1.1.1-Trichloroethane (Methylchloroform)

Specific brominated flame retardants such as the PBBOs and PBBs are not used in this product at all.



■ Package specification

Sleeve package

1. Through-Hole or SMT Gullwing

Package materials

Sleeve: HIPS (with anti-static material)

Stopper: Styrene-Elastomer

Package method

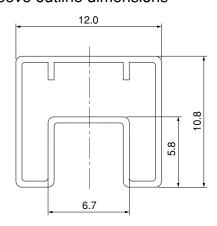
MAX. 50pcs of products shall be packaged in a sleeve.

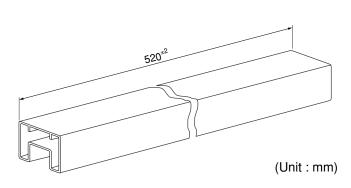
Both ends shall be closed by tabbed and tabless stoppers.

The product shall be arranged in the sleeve with its anode mark on the tabless stopper side.

MAX. 20 sleeves in one case.

Sleeve outline dimensions





2. Wide Through-Hole or Wide SMT Gullwing

Package materials

Sleeve: HIPS (with anti-static material)

Stopper: Styrene-Elastomer

Package method

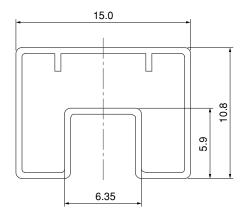
MAX. 50pcs of products shall be packaged in a sleeve.

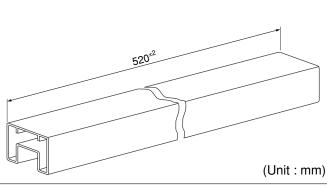
Both ends shall be closed by tabbed and tabless stoppers.

The product shall be arranged in the sleeve with its anode mark on the tabless stopper side.

MAX. 20 sleeves in one case.

Sleeve outline dimensions







● Tape and Reel package

1. SMT Gullwing

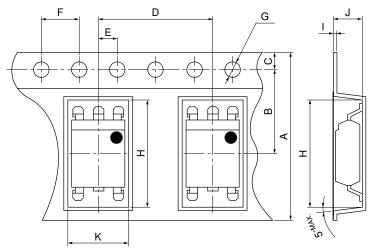
Package materials

Carrier tape: A-PET (with anti-static material)

Cover tape: PET (three layer system)

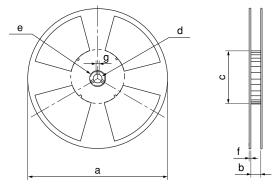
Reel: PS

Carrier tape structure and Dimensions



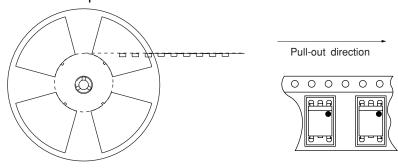
| | Dimensions List | | | | | | | |
|---|-----------------|---------------------|----------------------|---------------------|---------|---------------------|----------------------|--|
| | A | В | С | D | Е | F | G | |
| | 16.0±0.3 | 7.5 ^{±0.1} | 1.75 ^{±0.1} | 12.0±0.1 | 2.0±0.1 | 4.0 ^{±0.1} | φ1.5 ^{+0.1} | |
| Ī | Н | I | J | K | | | | |
| | 10.4±0.1 | 0.4±0.05 | 4.2 ^{±0.1} | 7.8 ^{±0.1} | | | | |

Reel structure and Dimensions



| Dimensio | ns List | (Unit: mm) | | | |
|----------|---------------------------------------|------------|--------|--|--|
| a | b | с | d | | |
| 330 | 330 17.5±1.5 e f 23±1.0 2.0±0.5 | | 13±0.5 | | |
| e | | | | | |
| 23±1.0 | | | | | |

Direction of product insertion



[Packing: 1 000pcs/reel]



2. Wide SMT Gullwing

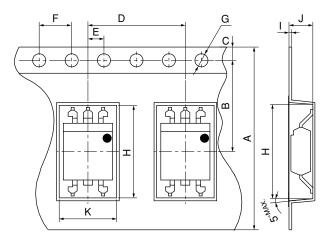
Package materials

Carrier tape: A-PET (with anti-static material)

Cover tape: PET (three layer system)

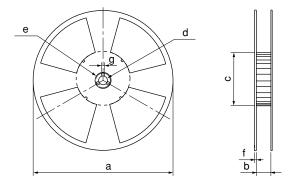
Reel: PS

Carrier tape structure and Dimensions



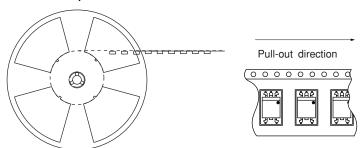
| Dimensions List (Unit: mn | | | | | | | |
|---------------------------|----------------------|----------------------|----------------------|----------------------|---------------------|---------------------|-----------------------|
| | A | В | C | D | Е | F | G |
| | 24.0 ^{±0.3} | 11.5 ^{±0.1} | 1.75 ^{±0.1} | 12.0 ^{±0.1} | 2.0 ^{±0.1} | 4.0 ^{±0.1} | φ1.5 + 0.1 |
| | Н | I | J | K | | | |
| | 12.2 ^{±0.1} | 0.4±0.05 | 4.15 ^{±0.1} | 7.6±0.1 | | | |

Reel structure and Dimensions



| Dimensio | ns List | (Unit: mm) | | | |
|----------|--|------------|--------------------|--|--|
| a | b | c | d | | |
| 330 | 25.5 ^{±1.5} | 100±1.0 | 13 ^{±0.5} | | |
| e | f | g | | | |
| 23±1.0 | 23 ^{±1.0} 2.0 ^{±0.5} | | | | |

Direction of product insertion



[Packing: 1 000pcs/reel]



■ Important Notices

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